

Ultra Micro Drill



φ0.075 Drilling Performance for CSP & BGA

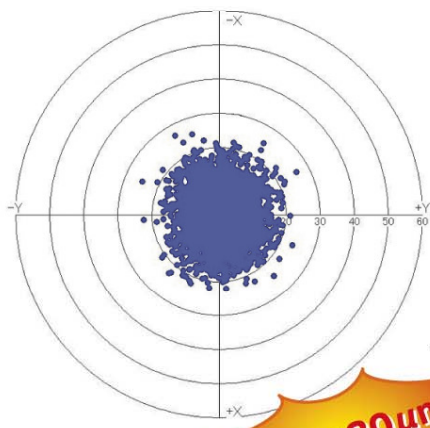
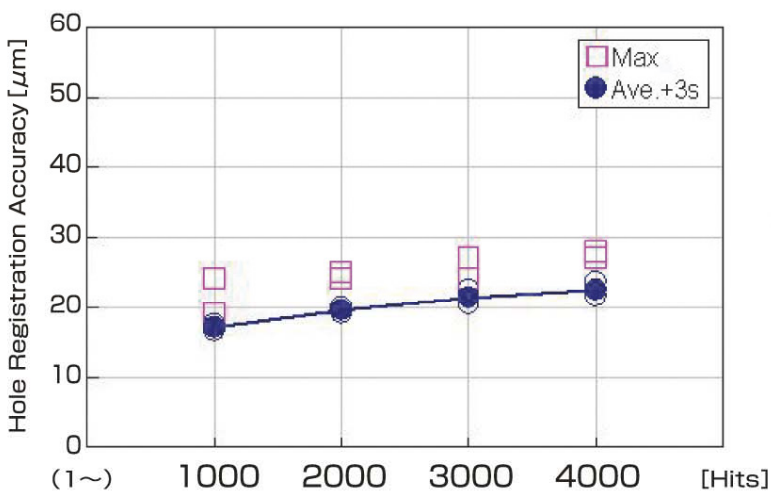
CSP & BGA用加工事例 (φ0.075)

加工条件 [Drilling Condition]

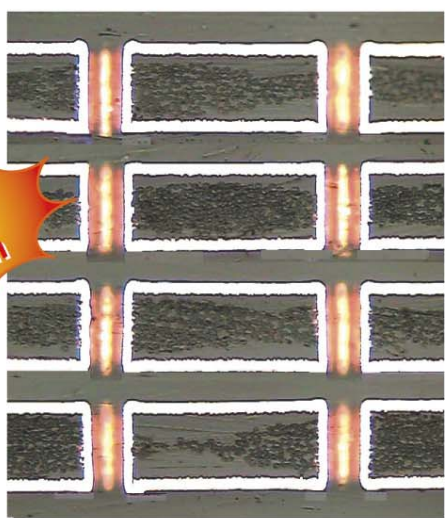
Work Material : BT CCL-HL832HS
 t0.1(double-sided) x 4stacks
 Set Life: 4,000hits



穴位置精度 [Hole Registration Accuracy]



内壁粗さ [Hole Wall Quality After 4000hits]



折損評価 [Breakage Life]

